1. Package summary

Terminal position code B (bottom)

Package type descriptive code WLCSP

Package type industry code WLCSP9

Package style descriptive code UC (uncased chip)

Package body material type X (other)

Mounting method type S (surface mount)

Number of package outline detail graphic

references

Issue date6-6-2018Manufacturer package codeWLCSP9Footprint dimensions (mm)1.7 x 1.7Footprint area (mm²)2.89

Table 1. Package summary

Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	1.45	-	1.48	1.51	mm
E	package width	1.45	-	1.48	1.51	mm
А	seated height	0.32	-	0.35	0.38	mm
A ₂	package height	0.19	-	0.2	0.21	mm
е	nominal pitch	-	-	0.5	-	mm
e ₁	minimal pitch	-	-	1	-	mm
n ₂	actual quantity of termination	-	-	9	-	



WLCSP9: wafer level chip-size package; 9 bumps (3 x 3)

2. Package outline

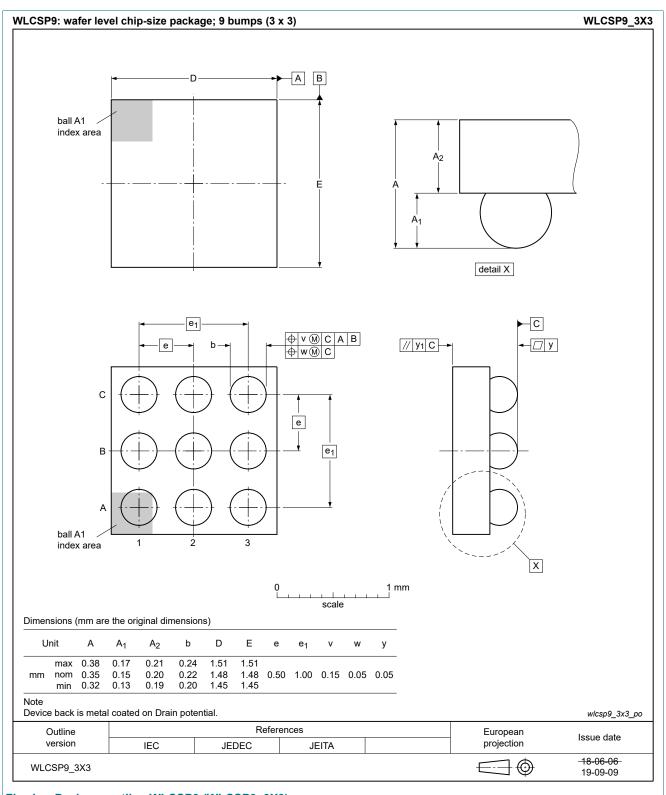
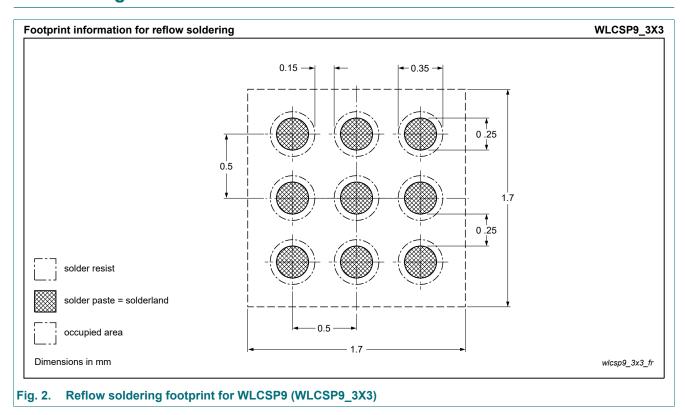


Fig. 1. Package outline WLCSP9 (WLCSP9_3X3)

Nexperia WLCSP9_3X3

WLCSP9: wafer level chip-size package; 9 bumps (3 x 3)

3. Soldering



WLCSP9: wafer level chip-size package; 9 bumps (3 x 3)

4. Legal information

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WLCSP9: wafer level chip-size package; 9 bumps (3 x 3)

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